# FAIRCHILD

SEMICONDUCTOR®

# FGL35N120FTD 1200V, 35A Trench IGBT

## Features

- Field Stop Trench Technology
- High Speed Switching
- Low Saturation Voltage: V<sub>CE(sat)</sub> = 1.68 V @ I<sub>C</sub> = 35A
- High Input Impedance ٠

# **Applications**

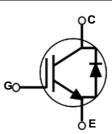
- Induction Heating And Microwave Oven
- Soft Switching Applications



**General Description** 

Using advanced field stop trench technology, Fairchild's 1200V trench IGBTs offer superior conduction and switching performances, and easy parallel operation with exceptional avalanche ruggedness. This device is designed for soft switching applications.





## **Absolute Maximum Ratings**

Symbol	Description		Ratings	Units	
V <sub>CES</sub>	Collector to Emitter Voltage		1200	V	
V <sub>GES</sub>	Gate to Emitter Voltage		$\pm 25$	V	
	Collector Current	@ T <sub>C</sub> = 25 <sup>o</sup> C	70	А	
I <sub>C</sub>	Collector Current	@ T <sub>C</sub> = 100 <sup>o</sup> C	35	A	
I <sub>CM (1)</sub>	Pulsed Collector Current	@ T <sub>C</sub> = 25°C	105	A	
I <sub>F</sub>	Diode Continuous Forward Current	@ T <sub>C</sub> = 100 <sup>o</sup> C	40	A	
P <sub>D</sub>	Maximum Power Dissipation	@ T <sub>C</sub> = 25°C	368	W	
	Maximum Power Dissipation	@ T <sub>C</sub> = 100 <sup>o</sup> C	147	W	
TJ	Operating Junction Temperature		-55 to +150	°C	
T <sub>stg</sub>	Storage Temperature Range		-55 to +150	°C	
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C	

Notes: 1: Repetitive rating: Pulse width limited by max. junction temperature

## **Thermal Characteristics**

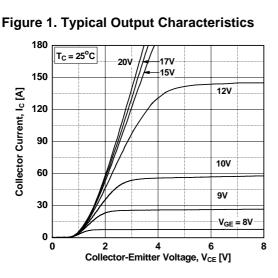
Symbol	Parameter	Ratings	Units	
R <sub>0JC</sub> (IGBT) Thermal Resistance, Junction to Case		0.34	°C/W	
$R_{\theta JC}(Diode)$	Thermal Resistance, Junction to Case	0.9	°C/W	
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient	25	°C/W	

		Device	Device Package Reel Size		Tape Width		Quantity	
		TO-264	го-264 -		-		30	
Electric	al Char	racteristics of the	e IGBT ⊺c=	25°C unless otherwise noted				
Symbol		Parameter	Tes	at Conditions	Min.	Тур.	Max.	Units
Off Charac	teristics							
BV <sub>CES</sub>	Collector	to Emitter Breakdown Volta	ge V <sub>GE</sub> = 0V,	$V_{GE} = 0V, I_{C} = 250 \mu A$		-	-	V
I <sub>CES</sub>	Collector	Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$		-	-	1	mA
I <sub>GES</sub>	G-E Leak	age Current		$V_{GE} = V_{GES}, V_{CE} = 0V$		-	±250	nA
On Charac	toristics				<b>I</b>	1	1	1
V <sub>GE(th)</sub>	1	shold Voltage	I <sub>C</sub> = 35mA	I <sub>C</sub> = 35mA, V <sub>CE</sub> = V <sub>GE</sub> 3.5		6.2	7.5	V
			-	$I_{\rm C} = 35$ A, $V_{\rm GE} = 15$ V		1.68	2.2	V
V <sub>CE(sat)</sub>	Collector	Collector to Emitter Saturation Voltage		/ <sub>GE</sub> = 15V, C	-	2.0	-	V
Dynamic C	haracteris	tics			-+	4	1	4
C <sub>ies</sub>	Input Cap			V <sub>CE</sub> = 30V, V <sub>GE</sub> = 0V, f = 1MHz		5090	-	pF
C <sub>oes</sub>	Output Ca	apacitance				180	-	pF
C <sub>res</sub>	Reverse	Fransfer Capacitance	f = 1MHz			95	-	, pF
Cwitching	Charaotari							
Switching	1	Delay Time			-	34	-	ns
t <sub>r</sub>	Rise Time				_	63	-	ns
t <sub>d(off)</sub>		Delay Time	Vee = 600	V, I <sub>C</sub> = 35A,	-	172	-	ns
t <sub>f</sub>	Fall Time	,	R <sub>G</sub> = 10Ω,	V <sub>GE</sub> = 15V,	-	107	-	ns
E <sub>on</sub>	Turn-On S	Switching Loss	Inductive L	₋oad, T <sub>C</sub> = 25ºC	-	2.5	-	mJ
E <sub>off</sub>	Turn-Off S	Switching Loss		-		1.7	-	mJ
E <sub>ts</sub>		ching Loss			-	4.2	-	mJ
t <sub>d(on)</sub>	Turn-On [	Delay Time			-	33	-	ns
t <sub>r</sub>	Rise Time	)			-	66	-	ns
t <sub>d(off)</sub>		Delay Time	$V_{CC} = 600$	V. Ic = 35A.	-	180	-	ns
t <sub>f</sub>	Fall Time		$R_{G} = 10\Omega$ ,	$V_{CC} = 600V, I_C = 35A,$ $R_G = 10\Omega, V_{GE} = 15V,$ Inductive Load, $T_C = 125^{\circ}C$		146	-	ns
E <sub>on</sub>	Turn-On S	Switching Loss	Inductive L			3.1	-	mJ
E <sub>off</sub>		Switching Loss			-	2.1	-	mJ
E <sub>ts</sub>	Total Swit	ching Loss			-	5.2	-	mJ
Q <sub>g</sub>	Total Gate	e Charge			-	210	-	nC
Q <sub>ge</sub>		mitter Charge		V, I <sub>C</sub> = 35A,	-	42	-	nC
Q <sub>gc</sub>		ollector Charge	V <sub>GE</sub> = 15V		_	101		nC

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Symbol	Parameter	Test Conditio	ns	Min.	Тур.	Max	Units
V <sub>FM</sub>	Diode Forward Voltage	I <sub>F</sub> = 35A	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	2.7	3.4	V
			$T_{C} = 125^{\circ}C$	-	2.5	-	
t <sub>rr</sub> D	Diode Reverse Recovery Time		$T_{\rm C} = 25^{\rm o}{\rm C}$	-	337	-	ns
			$T_{C} = 125^{\circ}C$	-	520	-	
I	Diode Peak Reverse Recovery	I <sub>F</sub> = 35A,	$T_{C} = 25^{\circ}C$	-	7.6	-	А
rr	Current	di/dt = 200A/µs	$T_{C} = 125^{\circ}C$	-	12.9	-	
Q <sub>rr</sub>	Diode Reverse Recovery Charge		$T_{\rm C} = 25^{\rm o}{\rm C}$	-	1292	-	nC
			$T_{C} = 125^{\circ}C$	-	3377	-	

# Electrical Characteristics of the Diode



**Typical Performance Characteristics** 

Figure 3. Typical Saturation Voltage Characteristics

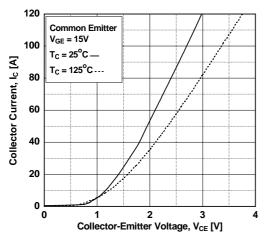


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

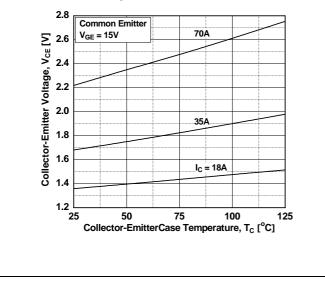


Figure 2. Typical Output Characteristics

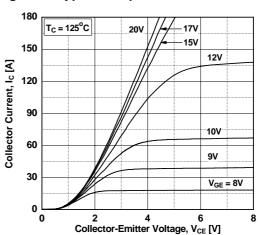


Figure 4. Transfer Characteristics

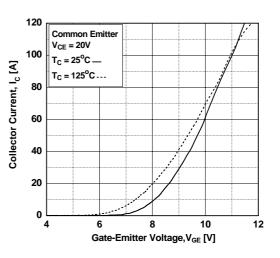
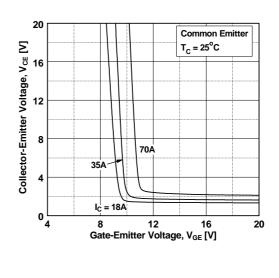
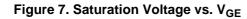


Figure 6. Saturation Voltage vs. V<sub>GE</sub>



# **Typical Performance Characteristics**



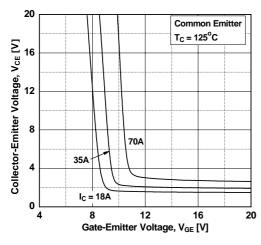


Figure 9. Capacitance Characteristics

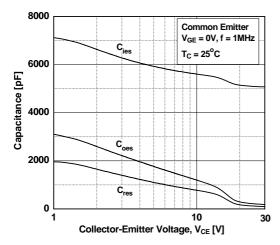


Figure 11. SOA Characteristics

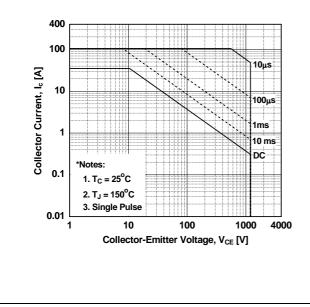


Figure 8. Load Current vs. Frequency

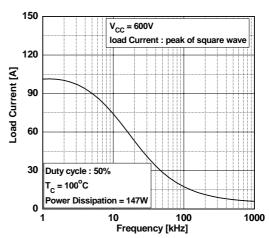


Figure 10. Gate Charge Characteristics

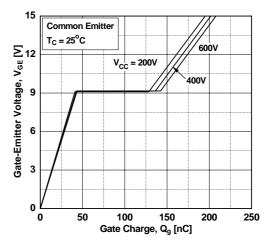
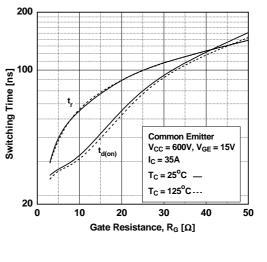
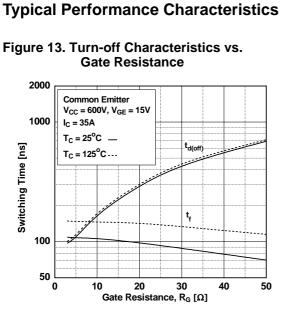
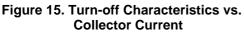


Figure 12. Turn-on Characteristics vs. Gate Resistance



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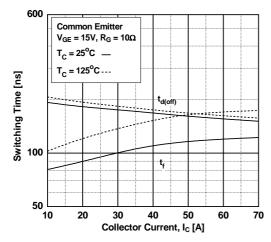


Figure 17. Switching Loss vs. Collector Current

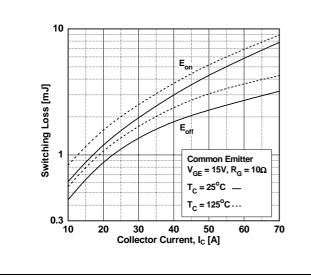


Figure 14. Turn-on Characteristics vs. Collector Current

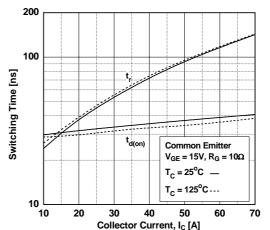


Figure 16.Switching Loss vs. Gate Resistance

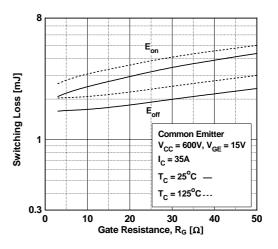
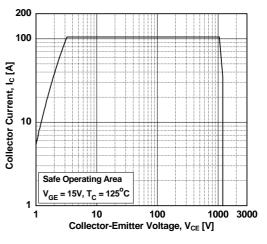
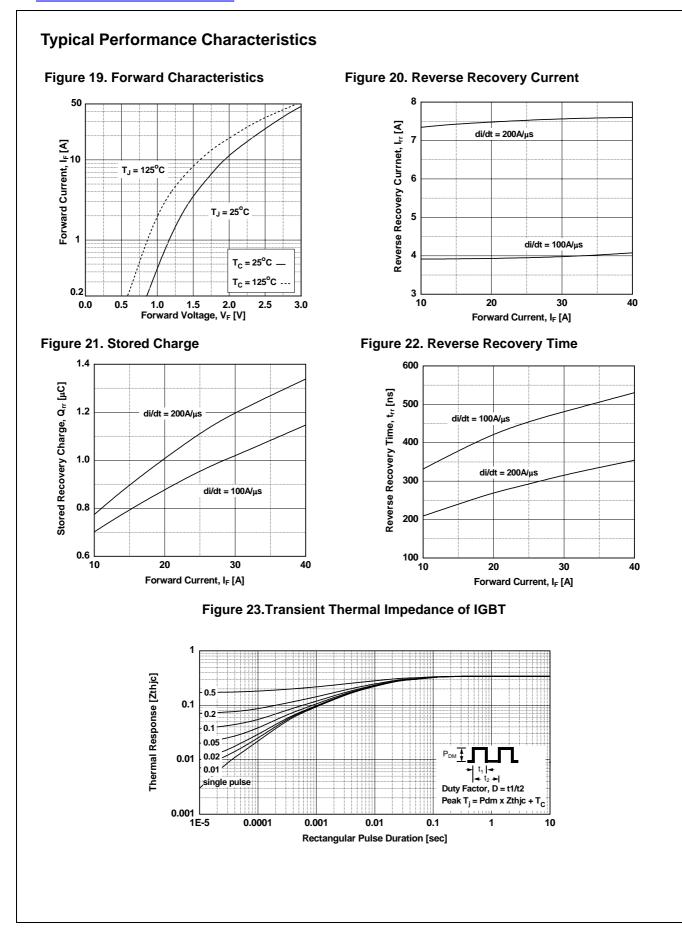
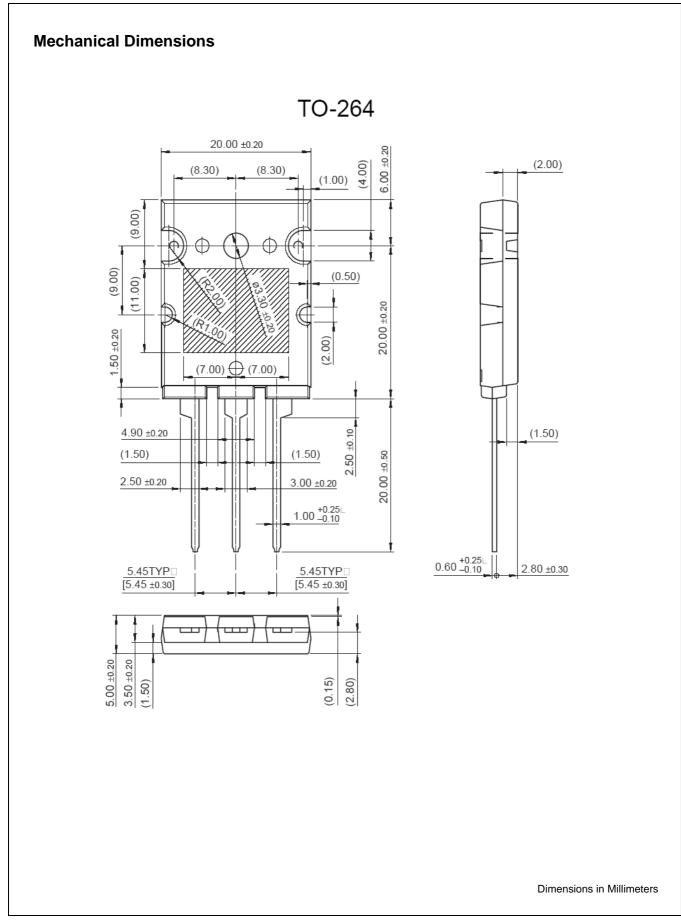


Figure 18. Turn off Switing SOA Characteristics



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